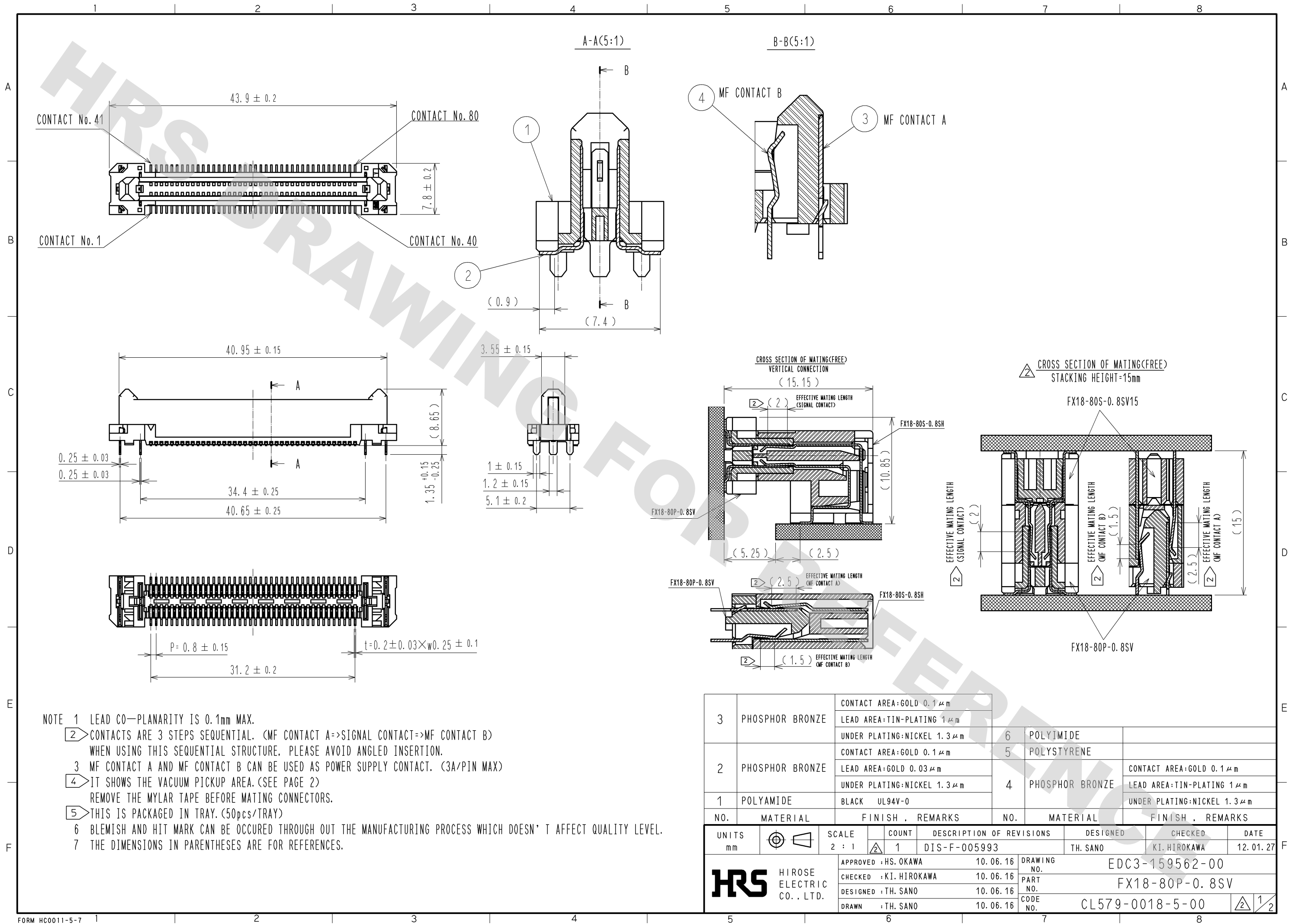
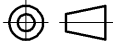


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3	PHOSPHOR BRONZE	CONTACT AREA:GOLD 0.1 μm		6	POLYIMIDE				
		LEAD AREA:TIN-PLATING 1 μm							
		UNDER PLATING:NICKEL 1.3 μm							
2	PHOSPHOR BRONZE	CONTACT AREA:GOLD 0.1 μm		5	POLYSTYRENE				
		LEAD AREA:GOLD 0.03 μm							
		UNDER PLATING:NICKEL 1.3 μm							
1	POLYAMIDE	BLACK UL94V-0		4	PHOSPHOR BRONZE	CONTACT AREA:GOLD 0.1 μm			
NO.	MATERIAL	FINISH . REMARKS				LEAD AREA:TIN-PLATING 1 μm			
						UNDER PLATING:NICKEL 1.3 μm			
				FINISH . REMARKS					
UNITS mm			SCALE 2 : 1		COUNT 1	DESCRIPTION OF REVISIONS DIS-F-005993	DESIGNED TH. SANO	CHECKED KI. HIROKAWA	DATE 12. 01. 27
 HIROSE ELECTRIC CO., LTD.			APPROVED : HS. OKAWA 10. 06. 16		DRAWING NO. EDC3-159562-00				
			CHECKED : KI. HIROKAWA 10. 06. 16		PART NO. FX18-80P-0. 8SV				
			DESIGNED : TH. SANO 10. 06. 16		CODE NO. CL579-0018-5-00				
			DRAWN : TH. SANO 10. 06. 16						
									

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08/11/2012

